

XBZ02P0911-G

Zener Diode

■FEATURES

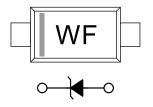
Environmentally Friendly: EU RoHS Compliant, Pb Free

■PRODUCT NAME

PRODUCT NAME	PACKAGE	ORDER UNIT
XBZ02P0911-G *	SOD-523P	5,000/Reel

^{*} The "-G" suffix denotes Halogen and Antimony free as well as being fully EU RoHS compliant

■MARKING



■ ABSOLUTE MAXIMUM RATINGS

Ta=25°C

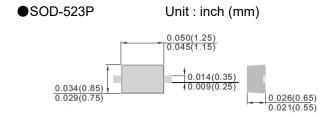
PARAMETER	SYMBOL	RATINGS	UNITS
Power Dissipation	Pd	200 (*1)	mW
Junction Temperature	Tj	150	°C
Storage Temperature	Tstg	-55 to +150	လ

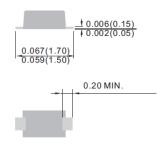
^(*1) PCB mounted

■ APPLICATIONS

Voltage Regulation

■ PACKAGING INFORMATION





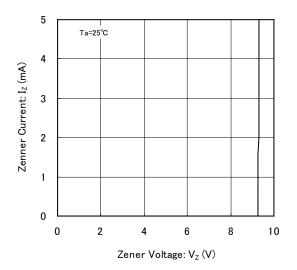
■ELECTRICAL CHARACTERISTICS

Ta=25°C

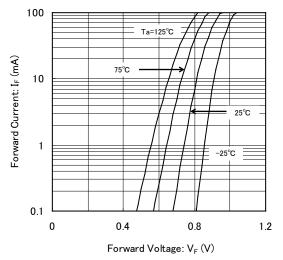
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Zener Voltage	Vz	I _{ZT} =5mA	8.65	9.1	9.56	V
Zener Impedance	Z _{ZT1}	I _{ZT} =5mA	-	-	15	Ω
	Z_{ZT2}	I _{ZT} =1mA	-	-	100	Ω
Reverse Current	I _R	V _R =6.0V	-	-	0.5	μΑ

■TYPICAL PERFORMANCE CHARACTERISTICS

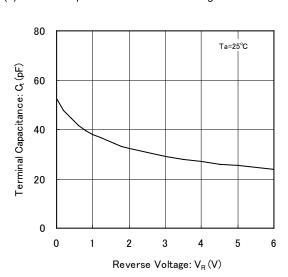
(1) Zener Current vs. Zener Voltage



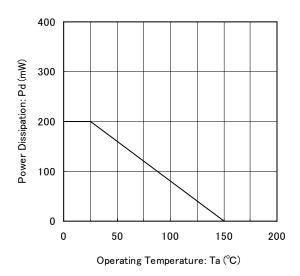
(2) Forward Current vs. Forward Voltage



(3) Terminal Capacitance vs. Reverse Voltage



(4) Power Dissipation vs. Operating Temperature



■NOTES ON USE

- 1. Please use this IC within the absolute maximum ratings.

 Even within the ratings, in case of high load use continuously such as high temperature, high voltage, high current and thermal stress may cause reliability degradation of the IC.
- 2. Torex places an importance on improving our products and their reliability.

 We request that users incorporate fail-safe designs and post-aging protection treatment when using Torex products in their systems.

■PACKAGING INFORMATION

For the latest package information go to, www.torexsemi.com/technical-support/packages

PACKAGE	OUTLINE / LAND PATTERN	THERMAL CHARACTERISTICS
SOD-523P	SOD-523P PKG	

- 1. The product and product specifications contained herein are subject to change without notice to improve performance characteristics. Consult us, or our representatives before use, to confirm that the information in this datasheet is up to date.
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- 3. Applicable export control laws and regulations should be complied and the procedures required by such laws and regulations should also be followed, when the product or any information contained in this datasheet is exported.
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- 6. Our products are not designed to be Radiation-resistant.
- 7. Please use the product listed in this datasheet within the specified ranges.
- 8. We assume no responsibility for damage or loss due to abnormal use.
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